

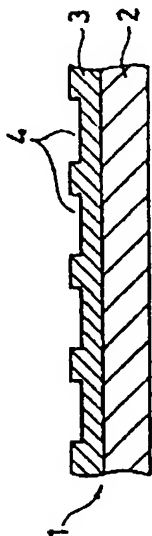
ABRASIVE TAPE AND MANUFACTURE THEREOF

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ABSTRACT

PURPOSE: To efficiently store the polishing chips formed from the body to be polished in case of polishing into the recessed part and to eliminate the danger of scratching the surface of the body to be polished by providing a lot the specified recessed parts on a polishing layer.

CONSTITUTION: A polishing layer 3 having numerous recessed parts 4 on at least one face of a film base material 2 is provided. In this case, the opening width of the recessed part 4 is taken in 0.1-200. μ m, the depth of the recessed part 0.1-100. μ m and the pitch of the recessed part 10-500. μ m. The recessed part 4 of the polishing layer 3 thus formed fulfils the function of storing the polishing chips formed from the body to be polished in case of polishing.



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